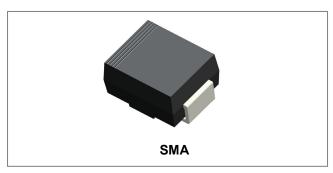


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10MQ040N SCHOTTKY RECTIFIER



Features

- Small foot print, surface moutable
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Applications

- Disk Drives
- Switching power supply
- Redundant power subsystems
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Battery Charging

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	-	40	V
Average Forward Current	I _{F(AV)}	50% duty cycle @T _L =105°C, rectangular wave form On PC board 9mm² island	1	Α
Peak One Cycle Non-Repetitive Surge Current	I _{FSM}	8.3 ms, half Sine pulse	36	А

Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop*	V _{F1}	@ 1 A, Pulse, T _J = 25 °C	0.52	0.54	V
-	V_{F2}	@ 1 A, Pulse, T _J = 125 °C	0.47	0.49	V
Reverse Current*	I _{R1}	$@V_R = Rated V_R, Pulse, T_J = 25 °C$	0.003	0.5	mA
	I_{R2}	$@V_R = Rated V_R, Pulse, T_J = 125 °C$	2	26	mA
Junction Capacitance	Ст	$_{T}$ @V _R = 5V, T _C = 25 °C $_{SIG}$ = 1MHz		70	PF
Typical Series Inductance	Ls	Measured lead to lead 5 mm from package body 2.0		-	nH
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs

^{*} Pulse width < 300 µs, duty cycle < 2%



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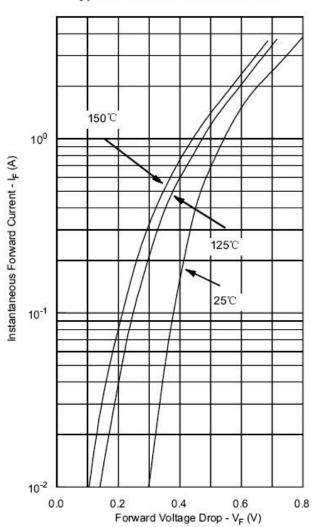


Thermal-Mechanical Specifications:

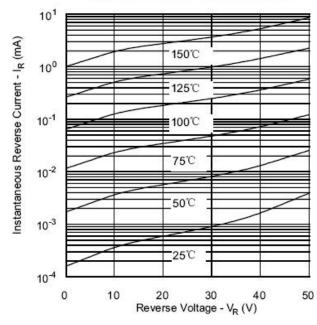
Characteristics	Symbol	Condition	Specification Unit	
Junction Temperature	T_J	-	-55 to +125	°C
Storage Temperature	T _{stg}	-	-55 to +150	°C
Typical Thermal Resistance Junction to Ambient	$R_{ heta JA}$	-	80	°C/W
Approximate Weight	wt	-	0.06	g
Case Style	SMA			

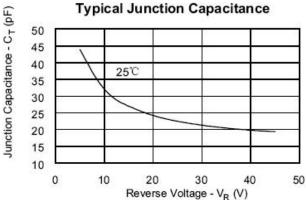
Ratings and Characteristics Curves

Typical Forward Characteristics



Typical Reverse Characteristics





- China Germany Korea Singapore United States
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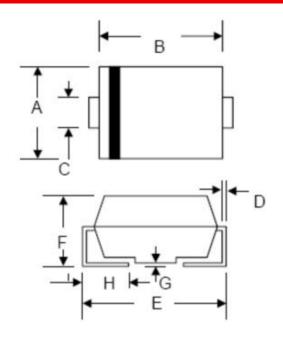


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Mechanical Dimensions SMA



SYMBOL	Milli	Millimeters		Inches	
STWIBUL	Min.	Max.	Min.	Max.	
Α	2.40	2.84	0.094	0.112	
В	3.99	4.75	0.157	0.187	
С	1.05	1.70	0.041	0.067	
D	0.15	0.51	0.006	0.020	
E	4.80	5.66	0.189	0.223	
F	1.90	2.95	0.075	0.116	
G	0.05	0.203	0.002	0.008	
Н	0.76	1.52	0.030	0.600	

Ordering Information

Device	Package	Shipping
10MQ040N	SMA (Pb-Free)	5000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram

SA1F xxxxx Where XXXXX is YYWWL

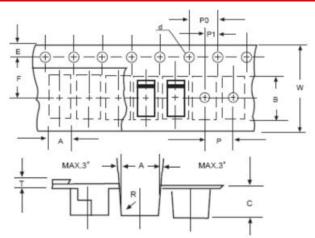
S = Device Type
A = Package Type
1 = Forward Current (1A)
F = Reverse Voltage (40V)
YY = Year
WW = Week

= Lot Number

Cautions: Molding resin

Epoxv resin UL:94V-0

Carrier Tape & Reel Specification SMA



SYMBOL	Millimeters		
STIVIBUL	Min.	Max.	
Α	2.97	3.17	
В	5.70	5.90	
С	2.32	2.52	
d	1.40	1.60	
Е	1.40	1.60	
F	5.60	5.70	
Р	3.90	4.10	
P0	3.90	4.10	
P1	1.90	2.10	
Т	0.25	0.35	
W	11.80	12.20	

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10MQ040N



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